SPECIFICATION

Device Name : SILICON DIODE

Type Name : YG123S15

Spec. No. : MS5D0383

Fuji Electric Co.,Ltd. Matsumoto Factory

	DATE	NAME	APPROVED			Fuji Electric Co.,Ltd.	
DRAWN	'97-10-8	S. Hotseshin	o.		Щ		
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Revised Records

Date	Classi- fication	Ind.	Content	Applied date	Drawn	Che	cked	Approved
OCT8 -1997	enactment	_		Issued date		M. IWAHARA		T. IDE
MAR4 -2003	alteration	а	•add characteristics •add P6∼P8	Issued date	J. Morimoto	T. HOSER	Klaush	7. Foyshira

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1. SCOPE

This specification provides the ratings and the test requirement for FUJI SILICON DIODE YG123S15

2. OUT VIEW, MARKING, MOLDING RESIN, CHARACTERISTICS

(1) Out view is shown

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(2) Marking is shown

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It is marked to type name or abbreviated type name, polarity and Lot No.

(3) Molding resin

Epoxy resin

UL:V-0

(4) Characteristics is shown

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3. RATINGS

3.1 MAXIMUM RATINGS

ITEM	SYMBOL	CONDITIONS	RATINGS	UNITS
Repetitive peak reverse voltage	VRRM		1500	V
Repetitive peak surge reverse voltage	V_{RSM}		1500	V
Isolating voltage	Viso	Terminals-to-Case,AC.1min	1500	V
Average output current	lo	Square wave duty =1/2 Tc = 92°C with fin	10	А
Non-repetitive surge current	İFSM	Sine wave, 10ms	80	Α
Operating junction temperature	Tj		150	$^{\circ}\!\mathbb{C}$
Storage temperature	Tstg		-40~+150	$^{\circ}\!\mathbb{C}$

3.2 ELECTRICAL CHARACTERISTICS (at Ta=25°C unless otherwise specified.)

ITEM	SYMBOL	CONDITIONS	MAXIMUM	UNITS
Forward voltage	VF	IF = 4 A	2.0	V
Reverse current	lr	Vr = Vrrm	50	μΑ
Reverse recovery time	trr	I _F = 0.1A,I _R =0.1A	0.5	μs
Thermal resistance	Rth(j-c)	Junction to case	3.5	°C/W

3.3 MECHANICAL CHARACTERISTICS

Mounting torque	Recommended torque	0.3~0.5	N∙m
Approximate mass		2.0	g

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4. TEST AND INSPECTION

4.1 STANDARD TEST CONDITION

Standard test condition Is Ta=25°C, RH=65%.

If judgement Is no doubt,the test condition Is possible to test In normal condition $Ta=5\sim35^{\circ}C$, RH=48 $\sim85\%$

4.2 STRUCTURE INSPECTION

It inspect with eye and measure, Item 2 shall be satisfied.

4.3 FORWARD AND REVERSE CHARACTERISTICS

It inspect on the standard condition, Item 3.2 shall be satisfied.

4.4 TEST

	Test	Test	Testing methods and Conditions	Reference	Sampling	Acceptance
H	No.	Items		Standard	number	number
				EIAJ ED4701		
	1	Terminal	Pull force			
		Strength	TO-220,TO-220F: 10N			
H		(Tensile)	TO-3P,TO-3PF,TO-247 : 25N	A-111A	5	
H			TO-3PL : 45N	method 1		
H			T-Pack,K-Pack : 10N			
H			Force maintaining duration :10±1s			
H	2	Terminal	Load force			
H		Strength	TO-220,TO-220F : 5N			
i I		(Bending)	TO-3P,TO-3PF,TO-247: 10N	A-111A	5	
H			TO-3PL: 15N	method 3		
H			T-Pack,K-Pack : 5N			
II			Number of times :2times(90deg./time)			
Mechanical test	3	Mounting	Screwing torque value: (M3)			(0:1)
 		Strength	TO-220,TO-220F: 40±10N	A-112	5	
<u>:</u> ë			TO-3P,TO-3PF,TO-247 : 50±10N	method 2		
la la			TO-3PL: 70±10N			
	4	Vibration	frequency: 100Hz to 2kHz			
≥			Acceleration: 100m/s ²	A-121	5	
H			Sweeping time : 4min./1 cycle			
11			4times for each X,Y&Z directions.			
H	5	Shock	Peak amplitude: 15km/s ²	A-122		
H			Duration time: 0.5ms	test code D	5	
H			3times for each X,Y&Z directions.			ļ
H	6	Solderability	Solder temp. : 235±5°C			
			Immersion time : 5±0.5s	A-131A	_	
			Each terminal shall be immersed in	test code A	5	
H			the solder bath within 1 to 3.0mm from			
H	_		the body.			
	7	Resistance to	Solder temp. : 260±5°C	1	_	
		Soldering Heat	Immersion time : 10±1s	A-132	5	
[└──]	Number of times : 1times			

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	Test No.	Test Items	Testing methods and Conditions	Reference Standard EIAJ ED4701	Sampling number	Acceptance number
	1	High Temp.	Temperature :Tstg max	B-111A	22	
		Storage	Test duration : 1000h			
	2	Low Temp.	Temperature : Tstg min	B-112A	22	
		Storage	Test duration : 1000h			
	3	Temperature	Temperature: 85±2°C	B-121A		
		Humidity	Relative humidity: 85±5%	test code C	22	
		Storage	Test duration : 500h			
	4	Temperature	Temperature: 85±2°C			
		Humidity	Relative humidity: 85±5%	B-122A	22	
_پ		Bias	Bias Voltage : V _{RRM} × 0.8	test code C		
Endurance test			Test duration : 1000h			
ė	5	Unsaturated	Temperature : 120±2°C			(0:1)
au		Pressurized	Relative humidity: 85±5%	B-123A	22	
5		Vapor	Vapor pressure : 170kPa	test code B		
ដ			Test duration : 96h			
"	6	Temperature	High temp.side : Tstg max			
		Cycle	Room temp. : 5~35°C			
			Low temp.side : Tstg min	B-131A	22	
			Duration time: HT 30min,RT 5min LT 30min			
			Number of cycles : 5 cycles			
	7	Thermal Shock	Fluid : pure water(running water)			
			High temp.side: 100+0/-5°C	B-141A	22	
			Low temp.side : 0+5/-0°C	test code A		
			Duration time: HT 5min,LT 5min			
			Number of cycles : 100 cycles			
	8	Steady state	Ta=25±5°C			
		Operating life	Rated load	D-402	22	
			Test duration : 1000h			
	9	Intermittent	Tj=Tjmax ∼50°C			
		Operating	3min ON, 3min OFF	D-403	22	
		Life	Test duration : 10000cy			
	10	High Temp.	Temperature : Ta= 100 °C			
		Reverse Bias	Bias Voltage : V _R =V _{RRM} duty=1/2	D-404	22	
			Test duration : 1000h			

Failure Criteria	$I_R \leq USL \times 5$
	V _F ≦USL x 1.1

USL:Upper specification Limit

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5.Cautions

etc.

- · Although Fuji Electric is continually improving product quality and reliability, a small percentage of semiconductor products may become faulty. When using Fuji Electric semiconductor products in your equipment, you are requested to take adequate safety measures to prevent the equipment from causing physical injury, fire, or other problem in case any of the products fail. It is recommended to make your design fail-safe, flame retardant, and free of malfunction.
- •The products described in this Specification are intended for use in the following electronic and electrical equipment which has normal reliability requirements.
- Computers •OA equipment •Communications equipment (Terminal devices)
- Measurement equipment
- Machine tools
- AV equipment

- •Electrical home appliances •Personal equipment
- Industrial robots
- •The products described in this Specification are not designed or manufactured to be used in equipment or systems used under life-threatening situations. If you are considering using these products in the equipment listed below, first check the system construction and required reliability.
- Transportation equipment (automobiles, trains, ships, etc.)
- Backbone network equipment

- Traffic-signal control equipment
- · Gas alarms, leakage gas auto breakers
- Submarine repeater equipment
- •Burglar alarms, fire alarms, emergency equipment
- Medical equipment

Nuclear control equipment

Do not use the products in this Specification for equipment requiring strict reliability such as (but not limited to):

 Aerospace equipment Aeronautical equipment

6.Warnings

- •The Diodes should be used in products within their absolute maximum rating (voltage, current, temperature, etc.). The Diodes may be destroyed if used beyond the rating.
- The equipment containing Diodes should have adequate fuses or protection to prevent the equipment from causing secondary destruction.
- ·Use the Diodes within their reliability and lifetime under certain environments or conditions. The Diodes may fail before the target lifetime of your products if used under certain reliability conditions.
- You must design the Diodes to be operated within the specified maximum ratings (voltage, current, temperature, etc.)to prevent possible failure or destruction of devices.
- · Consider the possible temperature rise not only for the junction and case, but also for the
- Do not directly touch the leads or package of the Diodes while power is supplied or during operation, to avoid electric shock and burns.

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- •The Diodes are made of incombustible material. However, if a Diode fails, it may emit smoke of flame. Also, operating the Diodes near any flammable place or material may cause the Diodes to emit smoke or flame in case the Diodes become even hotter during operation. Design the arrangement to prevent the spread of fire.
- The Diodes should not used in an environment in the presence of acid, organic matter, or corrosive gas (hydrogen sulfide, sulfurous acid gas.)
- •The Diodes should not used in an irradiated field since they are not radiation-proof.

Installation

- •Soldering involves temperatures which exceed the device storage temperature rating. To avoid device damage and to ensure reliability, observe the following guidelines from the quality assurance standard.
- •Solder temperature and duration (through-hole package)

Solder	Duration
temperature	
260±5°C	10±1second
350±10°C	3.0 ± 0.5 second

- The immersion depth of the lead should basically be up to the lead stopper and the distance should be a maximum of 1.5mm from the device.
- •When flow-soldering, take care to avoid immersing the package in the solder bath.
- •Refer to the following torque reference When mounting the device on a heat sink. Excess torque applied to the mounting screw causes damage to the device and weak torque will increase the thermal resistance, both of which conditions may destroy the device.

Table 1:Recommended tightening torque

rable 1:100011111011ada tigitteriirig terique						
Package style	Screw	Recommended tightening				
		torque				
TO-220	M3	30-50Ncm				
TO-220F						

- •The heat sink should have a flatness within $\pm 50\,\mu$ m and roughness within $10\,\mu$ m. Also, keep the tightening torque within the limits of this specification.
- •Improper handling may cause isolation breakdown leading to a critical accident.
- •We recommend the use of thermal compound to optimize the efficiency of heat radiation. It is important to evenly apply the compound and to eliminate any air voids.

Storage

- The Diodes must be stored at a standard temperature of 5 to 35°C and relative humidity of 45 to 75%. If the storage area is very dry, a humidifier may be required. In such a case, use only deionized water or boiled water, since the chlorine in tap water may corrode the leads.
- •The Diodes should not be subjected to rapid changes in temperature to avoid condensation on the surface of the Diodes. Therefore, store the Diodes in a place Where the temperature is steady.
- •The Diodes should not be stored on top of each other, since this may cause excessive external force on the case.
- The Diodes should not be stored with the lead terminals remaining unprocessed. Rust may cause presoldered connections to go fail during later processing.
- •The Diodes should be stored in antistatic containers or shipping bags.

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7.Appendix

- •These products do not contain PBDEs or PBBs.
- These products, assemblies, or components do not contain any of the above-mentioned substances.

Prohibited substances:

CFCs, halon, carbon tetrachloride, 1, 1, 1-trichloroethane (methyl chloroform)

These products, assemblies, or components are not manufactured using any of the above-mentioned substances.

Prohibited substances:

CFCs, halon, carbon tetrachloride, 1, 1, 1-trichloroethane (methyl chloroform)

- •If you have any questions about any part of this Specification, please contact Fuji Electric or its sales agentbefore using the product
- •Neither Fuji nor its agents shall be held liable for any injury caused by using the products not in accordance with the instructions.
- •The application examples described in this specification are merely typical uses of Fuji Electric products.
- This specification does not confer any industrial property rights or other rights, nor constitute a license for such rights.

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FUJI SILICON DIODE TYPE: YG123SIII OUT VIEW 外形寸法図 4.5 ±0.2 10 ±0.5 Ø3.2 +0.2 2.7 ±0.2 2.7±0.2 15±0.3 YG123S00 This material and the information herein is the property of Fuji Electric Co.,Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatever for the use of any third party nor used for the manufacturing purposes without the express written consent Fuji Electric Co.,Ltd. 1.2 ±0.2 13 min PRE-SOLDER 予備はんだ 1 (3) $0.6^{+0.2}_{0}$ 0.7 ±0.2 2.7 ±0.2 5.08 ±0.4 CONNECTION MARKING 結線図 表示内容 ① **-** 3 **((** Type name 形名 YG123S::: Polarity mark 整流記号 <u>Lot No.</u> ロットNo. UNIT:mm www.DataShee**a**u DWG.NO. Fuji Electric Co.,Ltd. MS5D0383

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Forward Characteristic (typ.) Reverse Characteristic (typ.) 10^{3} 102 Tj=150°C Tj=125°C Tj=100°C 10¹ Tj=150°C Reverse Current Tj=125°C Forward Current (A) -Tj=100°C 10° Tj=25°C 0.1 10⁻¹ This material and the information herein is the property of Fuji Electric Co., Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatever for the use of any third party nor used for the manufacturing purposes without the express written consent Fuji Electric Co., Ltd. 10-2 0.01 0 200 400 1000 1600 2.0 2.5 0.0 0.5 1.0 1.5 VR Reverse Voltage (V) VF Forward Voltage (V) Forward Power Dissipation (max.) Current Derating (lo-Tc) (max.) 160 150 140 20 130 \geq 360 18 120 Dissipation 110 16 100 14 Sine wave λ=180° Power Case Temperature Square wave λ=180°C 90 Sine wave λ=180°C -Square wave λ=180° 12 Square wave λ=120°C Forward 80 Square wave λ=60°C 10 70 ပ 60 40 30 Per 1element 20 lo Average Forward Current (A) lo Average Output Current (A) $\lambda : Conduction$ angle of forward current for each rectifier element lo:Output current of center-tap full wave connection www.DataSheeau .com Fuji Electric Co.,Ltd. MS5D0383 H04-004-03

